

# GT-DUVTK35-XX



## Product Description

Getian 3535 DUV series (Deep Ultraviolet), high reliable and grade Aluminum nitride ceramic substrate, is widely applied to sterilization and purification in the field of industry and medical with very low calorific value and high optical power. Its light efficacy is up to 10 mw with higher forward currents(max 100mA). This series is optimized for UV Sterilizers, UV curing, and Germicidal lamps, etc.

## Features

- Extremely wide viewing angle
- Suitable for all SMT assembly and Solder process
- Available on tape and reel
- Ceramic Substrate
- RoHS compliant
- Super Effective; Energy Saving; Environment Friendly.

## Application

- Air&Water Purification;
- Disinfection/Sterilization;
- Medical treatment and Personal Care;;
- Ink Curing&Nail Curing;
- Bio-analysis/detection;

## Table of Content

|                                    |   |
|------------------------------------|---|
| Characteristics.....               | 2 |
| Coding Rules.....                  | 2 |
| Specifications.....                | 3 |
| Spectral Features.....             | 4 |
| Electrical Features.....           | 4 |
| Typical Spatial Distribution ..... | 5 |
| Mechanical Dimensions.....         | 6 |
| Reliability Tests .....            | 7 |
| Notes .....                        | 8 |
| Notes .....                        | 9 |



## Characteristics

| Characteristics                 | Unit | Min | Typical     | Max  |
|---------------------------------|------|-----|-------------|------|
| Dimension L*W                   | mm   |     | 3.5*3.5*1.3 |      |
| Beam Angle $\theta$             | deg. |     | 120         |      |
| Half-wavelength $\Delta\lambda$ | nm   | 9   | 11          | 13   |
| Wavelength $\lambda_p$          | nm   | 270 | /           | 280  |
| Optical Power                   | mW   | 2.0 | 3.0         | 4.0  |
| Power Dissipation               | W    |     | 0.2         |      |
| DC Forward Current IF           | mA   |     | 40          |      |
| Forward Voltage VF              | V    | 5.0 |             | 7.0  |
| Thermal Resistance Rjs          | K/W  |     | 15          |      |
| Operating Temperature Top       | °C   | -30 |             | +60  |
| Storage Temperature Tst         | °C   | -40 |             | +100 |
| Testing Point Tc                | °C   |     |             | 60   |
| ESD (HBM)                       | V    |     |             | 8000 |
| Reflow Soldering (Lead-Free) ST | °C   |     |             | 180  |

## Coding Rules

| Model   | GT     | DUV                | 35           | X                 | XX           | X              |
|---------|--------|--------------------|--------------|-------------------|--------------|----------------|
| Code    | GT     | DUV                | Type         | C                 | Wavelength   | Optical Power  |
| Meaning | Getian | Deep UV LED Series | 3535 package | Ceramic Substrate | 275: 270-280 | B20: 2.0-4.0mW |

## Specifications (Tc = 25°C)

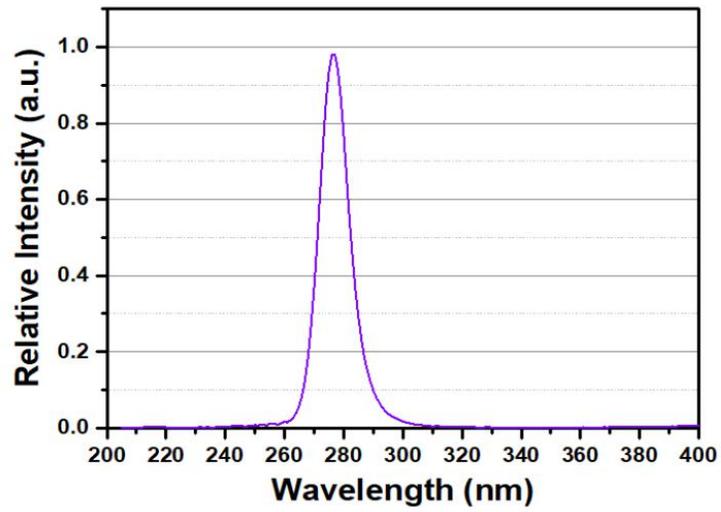
| Standard If: 40mA |                    | Typ Vf: 6V        |                    | Max Current: 50mA |                    | Max Optical Power: 2.0-4.0mW |         |
|-------------------|--------------------|-------------------|--------------------|-------------------|--------------------|------------------------------|---------|
| Product Type      | Part Number        | Viewing Angle (°) | Wavelength (λp nm) | Δλ (nm)           | Optical Power (mW) | VF (V)                       | IF (ma) |
| Deep UV LED       | GT-DUVTK35-275-B20 | 120               | 275±5nm            | 11±2nm            | 2.0-4.0            | 5.0-7.0                      | 40      |

### Notes:

Above charts include the most regular specs for DUV led series for reference. Please consult sales representative for specs that are not listed or please visit [www.getiangroup.com](http://www.getiangroup.com).

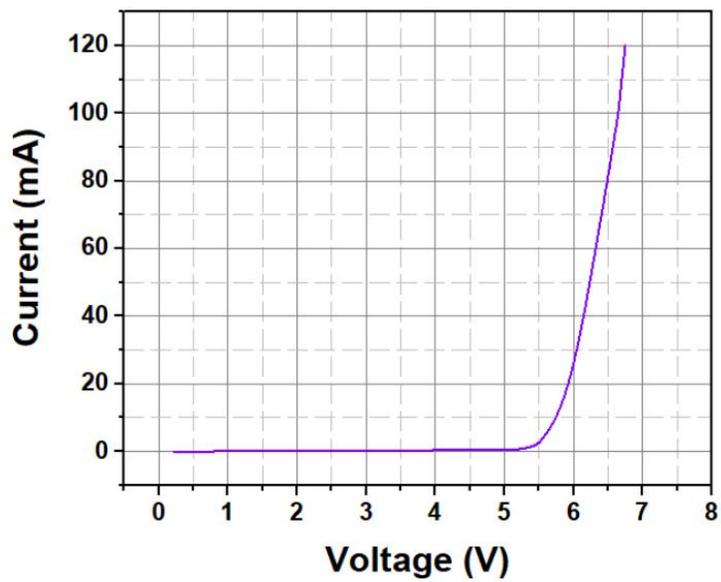
### Spectral Features (Tc = 25°C)

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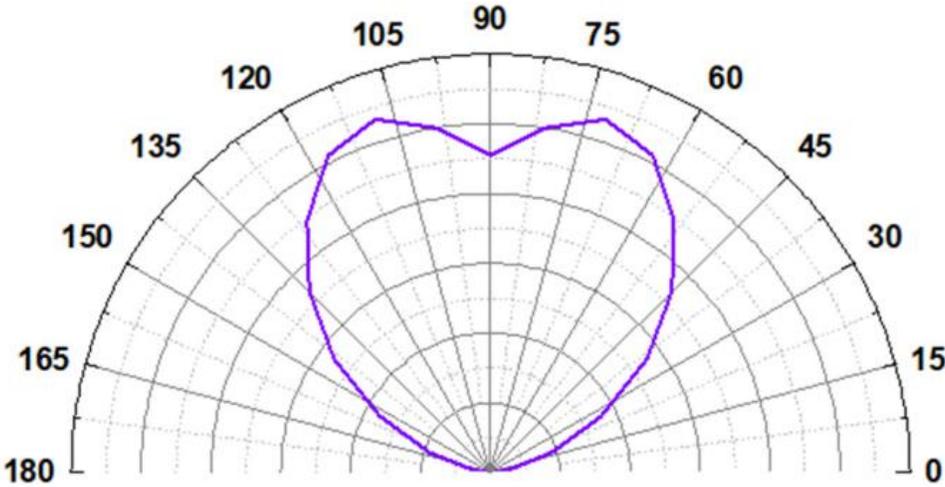


### Electrical Features (Tc = 25°C)

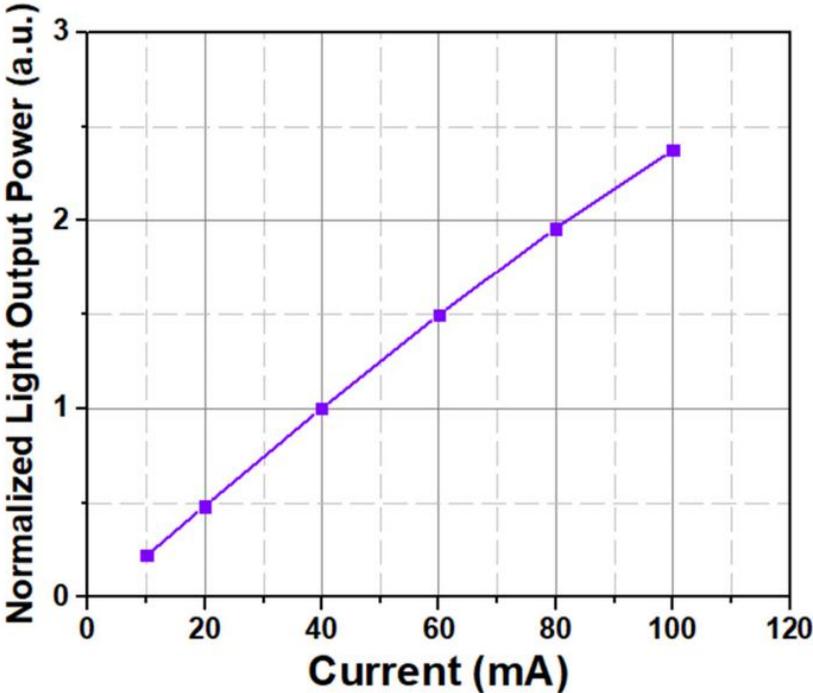
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Typical Spatial Distribution (Tc = 25°C)

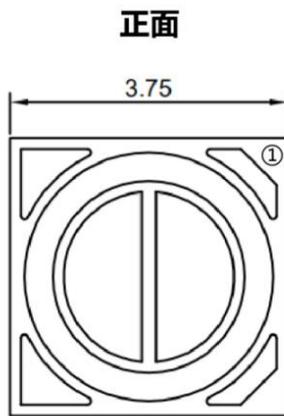


Relative Power VS Current (Tc = 25°C)

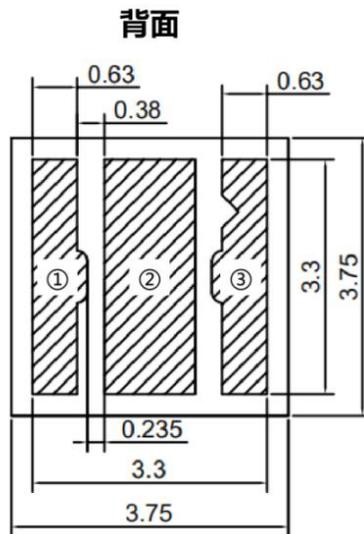


Dimensions (Unit:mm)

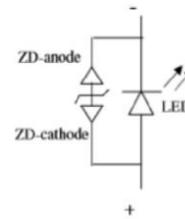
Tolerance +/-0.1mm



Front View



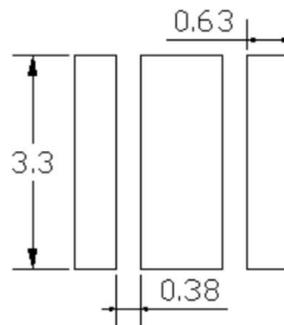
Back View



| 编号 | 功能   |
|----|------|
| ①  | 正极焊盘 |
| ②  | 导热焊盘 |
| ③  | 负极焊盘 |

- ① Anode Bonding Pad
- ② Die Heat Sink Pad
- ③ Cathode Bonding Pad

Bonding Pad Design



## Reliability Tests

| Test Items               | Test Conditions                                     |
|--------------------------|---|
| Aging Test               | 0.2W/IF=40mA<br>Ta=25°C × 1000hrs                   |
| Aging Test               | 0.2W/IF=40mA<br>Ta=85°C × 1000hrs                   |
| High Temperature Storage | 100°C × 1000 hours                                  |
| Low Temperature Storage  | -40°C × 1000 hours                                  |
| High Temp & Humidity     | IF=40mA<br>85°C, 85 %RH for 1000 hours              |
| Temperature Shock/Cycle  | -40°C × 30 minutes - +100°C × 30 minutes, 100 cycle |
| ESD (HBM)                | 4000V HBM/Time                                      |

## Criteria for Judging LED Failure(Tc=25°C)

| Items           | Symbol         | Test Conditions | Criteria for Judging LED Failure |
|-----------------|----------------|-----------------|----------------------------------|
| Forward Voltage | V <sub>F</sub> | 0.2W/IF=40mA    | >U × 1.1                         |
| Optical Power   | φ <sub>v</sub> | 0.2W/IF=40mA    | <S × 0.7                         |

## Handling Precautions

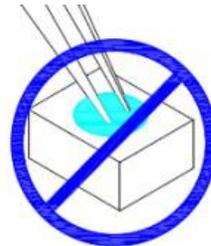
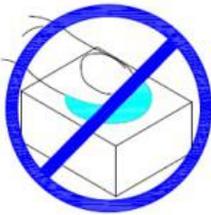
Compare to epoxy encapsulant that is hard and brittle, silicone is softer and flexible. Although its characteristic significantly reduces thermal stress, it is more susceptible to damage by external mechanical force. As a result, special handling precautions need to be observed during assembly using silicone encapsulated LED products.

Failure to comply might lead to damage and premature failure of the LED.

1. Handle the component along the side surface by using forceps or appropriate tools

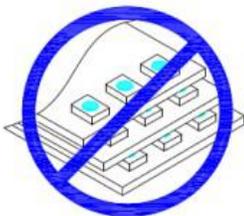


2. Do not directly touch or handle the silicone lens surface. It may damage the internal circuitry



3. Do not stack together assembled PCBs containing LEDs. Not available in the situation of acidity for PH Impact may scratch the silicone lens or damage

The internal circuitry

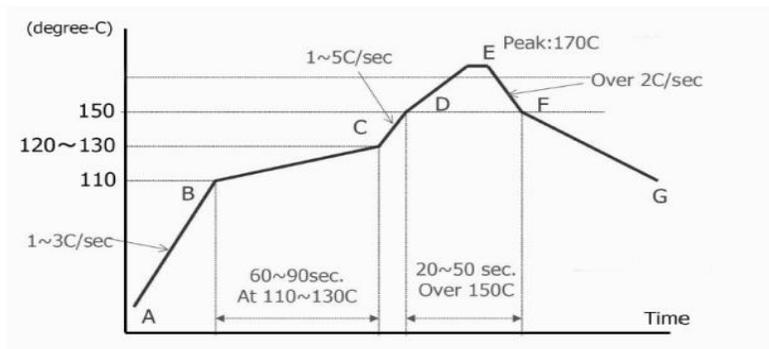


## Notes

- 1) **LED storage conditions:** temperature  $-30^{\circ}\text{C} \sim 100^{\circ}\text{C}$ , humidity  $30\% \sim 65\%$ , the package is sealed and stored;
- 2) **Handling method:** Wear gloves or finger cots when touching the LED; The work surface should also be grounded; Seal the bag in time after open it to prevent pin oxidation; After unpacking, the operator should use tweezers to hold the sides of the LED to avoid direct use of bare hand contact with the front of the LED;
- 3) **Installation:** This process is mainly for the protection of static electricity;
  - a. Check whether the grounding wire of the equipment is normal before production.
  - b. Check if the static ring of the personnel is normal and check whether the metal of the static ring is in close contact with the human skin.
  - c. The operators are highly recommended to wear static gloves or electrostatic finger cots during installation.
  - d. The work surface is required to be laid with electrostatic tape; The tapes should be connected to each other.
  - e. After opening, it is better to use up within 24 hours, otherwise it may cause oxidation and rust of the pins of led.
- 4) It is recommended to use low temperature solder paste for reflow soldering. The temperature curve is shown below:

The chip should be reflow soldered with low temperature solder paste, the peak temperature **should not be greater than  $170^{\circ}\text{C}$** , and the peak time should be controlled at about 20 seconds.

The reflow time should not be greater than 5 minutes. We recommend tin-bismuth / tin-silver-bismuth solder pastes, such as Sn42 / Ag1.0 / Bi57, SMIC L23-BLT5-T8F



- 5) As the current increases and the temperature rises, the LED's service life will decrease in a certain curve, resulting in faster LED attenuation.
- 6) It is recommended to have a grounding circuit when designing the PCB. Pay great attention to the LED working environment: the temperature is between  $-30^{\circ}\text{C}$  and  $60^{\circ}\text{C}$ , and the humidity is between 30% and 65%. Otherwise, there will be electrostatic breakdown and high current breakdown leading to dead light.
- 7) The photoelectric performance level of the products is determined by our company. The photoelectric performance of the products of different levels is different. Please take the method according to the conditions of use.
- 8) We are constantly working to improve the performance of LED products, specifications are subject to change without notice.

### Important safety tips

This product is a deep-UV LED that generates deep ultraviolet rays after being properly energized.

The ray is harmful to the skin and eyes of the human body. Directly exposed to deep ultraviolet light without any protective measures should be avoided;

It is strictly forbidden to directly contact ultraviolet rays without protective measures. It is strictly forbidden to look directly at ultraviolet rays without wearing protective glasses;

It is recommended to wear protective clothing, protective gloves and safety glasses through all the process of operation.